



III. ☐ This Statement is being filed under §1.97(c), with a statement under, §1.97(e) **prior** to either a final action, a notice of allowance or an action that otherwise closes prosecution in the application. The undersigned hereby states that (check one):

☐ each item of information contained in this Statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this Statement.

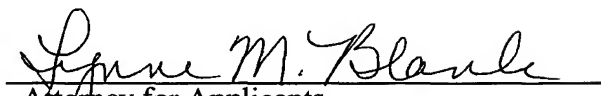
☐ no item of information in this Statement was cited in a communication from a foreign patent office in a counterpart foreign application and, to the knowledge of the person signing this certification statement under §1.97(e) after making reasonable inquiry, no item of information contained in this Statement was known to any individual designated in §1.56(c) more than three months prior to the filing of this Statement.

IV. ☐ This Statement is being filed under §1.97(d), with fee and statement under §1.97(e), on or after the mailing date of either a final action, a notice of allowance (but prior to payment of the issue fee) or an action that otherwise closes prosecution in the application. Please charge the fee required by §1.17(p) to Eastman Kodak Company Deposit Order Account No. 05-0225. A duplicate copy of this Statement is enclosed. The undersigned hereby states that (check one):


☐ each item of information in this Statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this Statement.

☐ no item of information in this Statement was cited in a communication from a foreign patent office in a counterpart foreign application and, to the knowledge of the person signing this certification Statement under §1.97(e) after making reasonable inquiry, no item of information contained in this Statement was known to any individual designated in §1.56(c) more than three months prior to the filing of this Statement.

Respectfully submitted,

  
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Enclosures

<b>FORM PTO-1449</b> <b>US DEPARTMENT OF COMMERCE</b> <b>PATENT AND TRADEMARK OFFICE</b>		Atty. Docket No. <b>82859LMB</b> Customer No. <b>01333</b>		Serial No. <div style="text-align: center;">   <b>10/008428</b>  <b>11/13/01</b> </div>	
If AFTER the later date of the first Office Action or 3 months from filing, use only with Rule 97(E) Certificate or Fee  <b>LIST OF ART CITED BY APPLICANT</b> <small>(Use several sheets if necessary)</small>		Applicant: <b>Narasimharao Dontula, et al</b>		Filing Date  Group	

U.S. PATENT DOCUMENTS						
Examiner Initial*	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
	4,739,007	04/19/88	Okada et al.			
	4,810,734	05/07/89	Kawasumi et al.			
	4,894,411	01/16/90	Okada et al.			
	5,102,948	04/07/92	Deguchi et al.			
	5,164,440	11/17/92	Deguchi et al.			
	5,164,460	11/17/92	Yano et al.			
	5,248,720	09/28/93	Deguchi et al.			
	5,385,776	01/31/95	Maxfield et al.			
	5,514,734	05/07/96	Maxfield et al.			
	5,552,469	09/03/96	Beall et al.			
	5,578,672	11/26/96	Beall et al.			
	5,698,624	12/16/97	Beall et al.			
	5,721,306	02/24/98	Tsipursky et al.			
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	5,804,613	09/08/98	Beall et al.			
	5,830,528	11/03/98	Beall et al.			
	5,880,197	03/09/97	Beall et al.			
	5,973,053	10/26/99	Usuki et al.			

FOREIGN PATENT DOCUMENTS						
Examiner Initial*	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION YES   NO

OTHER ART (Including Author, Title, Date, Pertinent Pages, Etc.)	
	A. Okada et al., Polym Prep., 1987, Vol. 28, pages 447-448
	Rachel Levy and C.W. Francis, Journal of Colloid And Interface Science, March 1975, Vol. 50 (3), 442-450
	D.J. Greenland, Journal of Colloid Science, Vol. 18, 1963, pages 647-664
	Richard A. Vaia et al., New Polymer Electrolyte Nanocomposites: Melt intercalation of polyethyleneoxide in mica type silicates, Advanced Materials, 7(2), 1995, pages 154-156
	V. Mehrotra, E.P. Giannelis, Solid State Communications, 1991, Vol. 77, No. 2, pages 155-158
	Ed. T.J. Pinnavia and G.W. Beall, John Wiley & Sons, Ltd. Publishers, Polmer-Clay Nanocomposites, 2000
	H. van Olphen, John Wiley & Sons, Ltd. Publishers, An Introduction To Clay Colloid Chemistry, 1963, 1977
	Co-pending USSN 09/_____, Dontula et al., <i>Ethoxylated Alcohol Intercalated Smectite Materials</i> (D-82056)
	Co-pending USSN 09/_____, Majumdar et al., <i>Smectite Clay Intercalated With Polyether Block Polyamide Copolymer</i> (D-82857)
	Co-pending USSN 09/_____, Nair et al., <i>Polyester Nanocomposites</i> (D-82858)

EXAMINER	DATE CONSIDERED
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\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.